MICRO SIM CARD SOCKET PUSH-PUSH TYPE



5562 SERIES. Micro Sim Card Socket 8 contacts.

General Features

- Available in 8 contacts
- Accept Micro SIM card 8 contacts
- Contact area: different gold plating over 50 μ nickel
- Solder area: 100μ tin plating over 50 μ nickel
- Stand-off: 0 mm. With SMT fixing tabs.
- With card detect

Materials

- Insulator: high temperature thermoplastic UL 94 V-0
- Contact: Brass
- Switch terminal: brass
- Shell: SUS304 t=0.20 mm.
- Operating temperature. -25°C to +85°C
- RoHS compliant

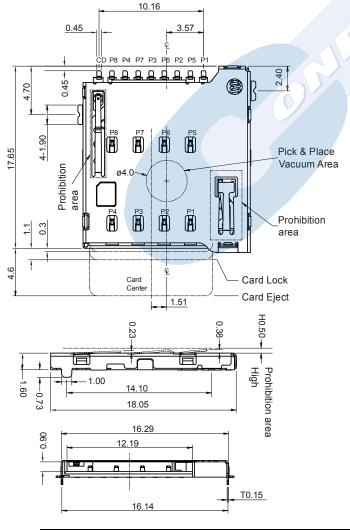
Electrical Features

- Voltage rating: < 10 V
- Current rating: < 0.50 A
- Contact resistance: < 100 mΩ contact
- Contact resistance: $< 140 \text{ m}\Omega$ card detect
- Dielectric withstanding voltage: 500 V AC/minute
- Insulation resistance: >1000 $M\Omega$

Mechanical Features

- Contact retention force: > 0.10 Kgf
- Insertion force: < 0.98 Kgf
- Withdrawall force: >0.050 Kgf
- Durability: 5.000 cycles

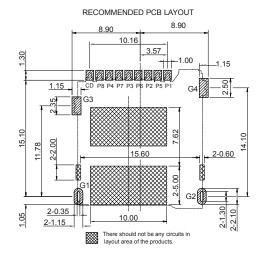
Dimensional Information

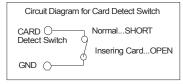


SIM CARD Distribution Pin									
C1	C2	C3	C4	C5	C6	C7	C8	G1-G4	CD
VCC	RST	CLK	Reser.	GND	VPP	I/O	Reser.	GND	Card detector

5562 - <u>T</u>- <u>XX</u>- <u>E</u>

- 1. Series
- 2. Plating Options
- T = 3. Gold flash over nickel Recommended Finish
- 3. Number of circuits
- Available in 08 circuits
- 4. Packing Options
- E = 2. Reel





E-XX FULL LINE CATALOGUE